RECORDATION FORM COVER SHEET

9-18-04

PATENTS ONLY



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To the Honorable Commissioner of Pa	tents and Trademarks: Please record the attached	original documents or copy thereof.
Name of conveying party Kenichiro NAGASAKA Additional name(s) of conveying party(ies) attached?YesX_No	2. Name and address of SONY CORPORATI 7-35 Kitashinagawa 6 Shinagawa-Ku, Toky	ON 6-chome
3. Nature of conveyance: X Assignment Security Agreement Merger Change of Name Other Execution Date(s): August 25, 2006.	Additional name(s) &	address(es) attached?Yes _X_No
 Application number(s) or patent number(s): If this document is being filed together with a new A. Patent Application No. <u>11/490,759</u> filed <u>July</u> Additional numbers attached? <u>Yes X</u> No 	<u>21, 2006</u> .	n is: 5
 Name and address of party to whom correspondence condocument should be mailed: Name: WILLIAM S. FROMMER Internal Address: FROMMER LAWRENCE & HAU Street Address: 745 FIFTH AVENUE 	7. Total fee (37 CFR 3.4 E HAUG LLP X Enclosed	ications and patents involved 1 41) \$\frac{40.00}{20}\$ charged to deposit account 50-0320
City: NEW YORK State: NY Z	8. Deposit account num	ber: by of this page if paying by deposit account)
	Do not use this space	
 Statement and signature. To the best of my knowledge and belief, the foregone 	going information is true and correct and any attac	ched copy is a true copy of the original document.
Thomas F. Presson, Reg. No. 41,442	Thomas Fresh	September 15, 2006
Name of Person Signing	Signature	Total number of pages including cover sheet, attachments, and document:
	ompleting and reviewing the sample cover sheet. Iformation Systems, PK2-1000C, Washington, D	ument to be recorded, including time for reviewing Send comments regarding this burden estimate to p.C. 20231, and to the Office of Magagement and
		90 90

FLH Docket Number: 450100-05864

ASSIGNMENT

WHEREAS, I, as below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

ROBOT APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese Corporation, with offices at 7-35 Kitashinagawa 6-chome, Shinagawa-Ku, Tokyo, 141-0001, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/490,759, Filing Date: July 21, 2006.

This assignment executed on the dates indicated below.

Kenichiro NAGASAKA		
Name of sole or 1st inventor	Execution date of U.S. Patent Application	
Tokyo, Japan		
Residence of sole or 1st inventor	Aug. 25, 2016	
Signature of sole or 1st inventor	Date of this assignment	

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PATENT REEL: 018310 FRAME: 0624

RECORDED: 09/18/2006